## MODEL NO. : <u>G1601FP104GG-001</u> ISSUED DATE: <u>2017-12-01</u> VERSION : A0

# Preliminary Specification Final Product Specification

#### Customer :\_

Approved by	Notes

#### GVO Confirmed :

Prepared by	Checked by	Approved by
余级	FA. 10. 社:	おきま

This technical specification is subjected to change without notice.

# MODEL NO. : G1601FP104GG-001 ISSUED DATE: 2017-12-01 VERSION : A0

# Preliminary SpecificationFinal Product Specification

#### Customer :

Approved by	Notes

#### **GVO Confirmed :**

Prepared by	Checked by	Approved by
6		

This technical specification is subjected to change without notice.



₩ 🖶 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

### **Table of Contents**

Tab	le of Contents	3
Rec	cord of Revision	4
1	General Specifications	5
2	Input/output Terminals	6
3	<ul> <li>2.1 Main FPC Pin Assignment</li> <li>2.2 Circuit block diagram (Display)</li> <li>2.3 MCU and Display Module Interface Configuration</li> <li>Absolute Maximum Ratings</li> </ul>	8 8 9
4	3.1 Driving AMOLED Panel Electrical Characteristics	9
5	4.1 Driving AMOLED Panel	
6	<ul> <li>5.1 MIPI Interface Characteristics</li></ul>	12 13 14
7	<ul> <li>6.1 Display Power on / off Sequence</li> <li>6.2 Brightness control</li> <li>Optical Characteristics Optical Specification</li> </ul>	15
8	Environmental / Reliability Test	
9	Quality Level	23
10	<ul> <li>9.1 AMOLED Module of Characteristic Inspection</li></ul>	23 23
11	Precautions for Use of AMOLED Modules	33
	<ul> <li>11.1 Handling Precautions:</li> <li>11.2 Storage Precautions:</li> <li>11.3 Transportation Precautions:</li> </ul>	33



#### ■ 〒 米 电 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001 Record of Revision

Rev	Issue Date	Description	Editor
A0	2017-12-01	Draft	Yu Wei
			r



#### ■ 光 电 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

#### 1 General Specifications

	Feature	Spec	Remark
	Screen Size (inch)	6.01	
Display Spec Mechanical Characteristi cs Electronic	Display Mode	AMOLED	
	Resolution(dot)	1080(W)×2160(H)	
	Active Area(mm)	68.256(W)×136.512 (H)	
Display Spec	Pixel Pitch (um)	63.2 (W)×63.2(H)	
	Technology Type	LTPS	
	Color Depth	16.7M	
	Interface	MIPI 4LANE	
	Surface Treatment	Hard Coating	
	With TP/Without TP	With TP(on Cell)	
Characteristi	Module Outline Dimension(W x H x D) (mm)	70.066(W)x140.917(H)x0.723(D)	
	Weight (g)	TBD	
Electronic	Driver IC(Type)	RM69299	
	Touch IC(Type)	GT1151	

Note 1: Requirements on Environmental Protection: RoHS.



#### **B W H** KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001 **2** Input/output Terminals

#### 2.1 Main FPC Pin Assignment

FPC connector: BM24-50DS/2-0.35V(51) (Socket), B-TO-B Connector.

Main board recommended connector: BM24-50DP/2-0.35V(51) (Header), B-TO-B Connector.

No	Symbol	I/O	Description
1	GND	GND	Ground
2	ELVSS	Р	Negative power supply for EL
3		Р	Power supply for MTP Programming or Erase.
	VPP		If it is not used, please let it open.
4	ELVSS	Р	Negative power supply for EL
5	GND	GND	Ground
6	ELVSS	Р	Negative power supply for EL
7	D3N	Ι	MIPI data lane
8	GND	GND	Ground
9	D3P	Ι	MIPI data lane
10	ELVDD	Р	Positive power supply for EL
11	GND	GND	Ground
12	ELVDD	Р	Positive power supply for EL
13	D0N	Ι	MIPI data lane
14	ELVDD	Р	Positive power supply for EL
15	D0P	Ι	MIPI data lane
16	GND	GND	Ground
17	GND	GND	Ground
18	RESX	Ι	Display reset. Active low.
19	CLKN	Ι	MIPI clock lane
20	AVDD_EN	0	Power IC enable control pin
21	CLKP	Ι	MIPI clock lane
22	SWIRE	0	Control signal for power IC
23	GND	GND	Ground
24	ERR_FG	0	Error status of MIPI's HSDT
25	D1N	I	MIPI data lane

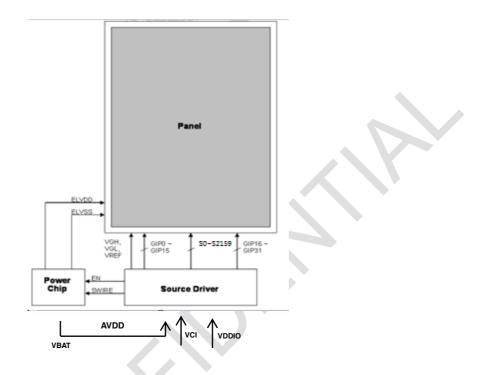


#### 国 显 光 电 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

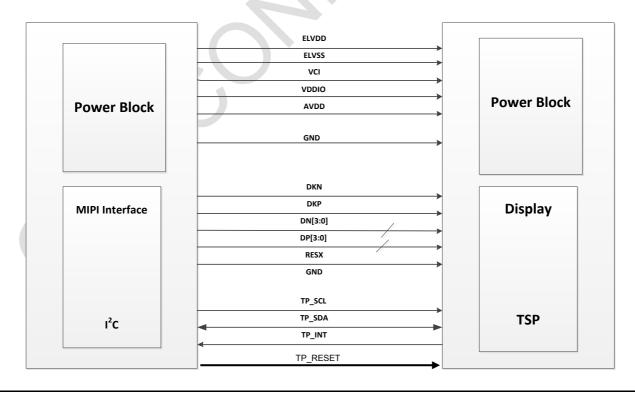
Ψπ		ISIONUX OFIC	PELECTRONICSCO., LID GIOUTPI04GG-001
26	PCD	Ι	panel crack detection
27	D1P	Ι	MIPI data lane
28	TE	Ι	Sync Signal for preventing Tearing Effect
29	GND	GND	Ground
30	GND	GND	Ground
31	D2N	Ι	MIPI data lane
32	TSP_AVDD_3.3V	Р	Analog Power for TP
33	D2P	Ι	MIPI data lane
34	AVDD	Р	Power supply for Analog system
35	GND	GND	Ground
36	VCI	Р	Power supply for display analog circuits
37	TSP_DVDD_1.8V	Р	Power supply for TP logic circuits
38	VDDIO	Р	Power supply for interface system except MIPI/MDDI interface
39	_	NC	
-	TSP_TA		
40	GND	GND	Ground
41	TSP_INT	Ι	Interrupt signal for TP
42	F_SCLK	Ι	Flash signal
43	TSP_SCL	Ι	SCL pin for TP
44	F_CSN	Ι	Flash signal
45	TSP_SDA	I/O	SDA pin for TP
46	F_IO<0>	I/O	Flash signal
47	TSP_RESET	Ι	Reset Pin for TP, Active low.
48	F_IO<1>	I/O	Flash signal
49	GND	GND	Ground
50	GND	GND	Ground

Note: I=Input; O=Output; P=Power; I/O=Input / Output

**GVO KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD** G1601FP104GG-001 2.2 Circuit block diagram (Display)



2.3 MCU and Display Module Interface Configuration



# GVO

#### ■ ₩ ₩ KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001 3 Absolute Maximum Ratings

#### 3.1 Driving AMOLED Panel

Maximum Ratings (Voltage Referenced to VSS) Vss=0V, Ta=25 $^\circ\!\!\mathrm{C}$ 

Item	Symbol	MIN	MAX	Unit
Analog Power supply	VCI	-0.3	+5.5	V
Logic Power supply	VDDIO	-0.3	+5.5	V
Positive Power Input	ELVDD	-	+5.0	V
Negative Power Input	ELVSS	-5.0	-	V
TP power supply Input	TSP_AVDD	-0.3	+4.2	V
TP power supply for logic circuits	TSP_DVDD	-0.3	+4.2	V

Note: Functional operation should satisfy the limits in the Electrical Characteristics tables or Pin Description section. If the module exceeds the absolute maximum ratings, permanent damage may occur. Besides, if the module is operated with the absolute maximum ratings for a long time, the reliability may also drop.

#### 4 Electrical Characteristics

4.1 Driving AMOLED Panel

Item		Symbol	MIN	TYP	MAX	Unit
Logic Power	Logic Power supply		1.65	1.80	3.3	V
Analog Powe	er supply	VCI	2.5	2.80	3.60	V
ELVDD Supp		ELVDD	4.55	4.60	4.65	V
ELVSS Supp	ly Voltage	ELVSS	-5	-3	-	V
TP power su		TSP_AVDD	2.6	2.8	3.3	V
TP power supply for logic circuits		TSP_DVDD	1.53	1.8	3.3	V
Input Signal High Level		VIH	0.80*VDDIO	-	VDDIO	V
Voltage	Low Level	VIL	0.00	-	0.20*VDDIO	V
Output	High Level	VOH	0.80*VDDIO	-	VDDIO	V
Signal Voltage	Low Level	VOL	0.00	-	0.20*VDDIO	V
		I <sub>ELVDD</sub> /I <sub>ELVSS</sub>	-	TBD	TBD	mA
No		I <sub>VCI</sub>	-	TBD	TBD	mA
Normal		I <sub>VDDIO</sub>	-	TBD	TBD	mA
		l <sub>avdd</sub>	-	TBD	TBD	mA
Chan d hu		I <sub>VCI</sub>	-	TBD	TBD	uA
Sta	nd-by	I <sub>VDDIO</sub>	-	TBD	TBD	uA

Ta=25℃



#### I 显光电 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

Note1: The input digital voltage is the I/O reference voltage.

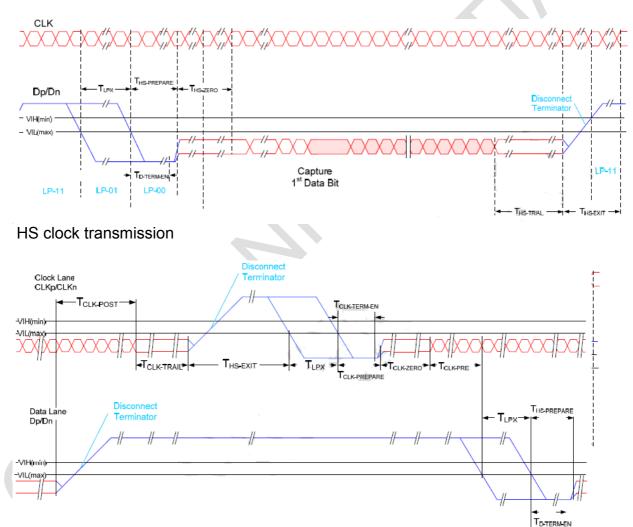
Note2: VDDIO usually ranges from 1.65V to 3.3 V. If VDDIO is changed, the remaining voltage needs to be changed to the same voltage as VDDIO.

Note3: Under full white pattern, Video Mode 60Hz.

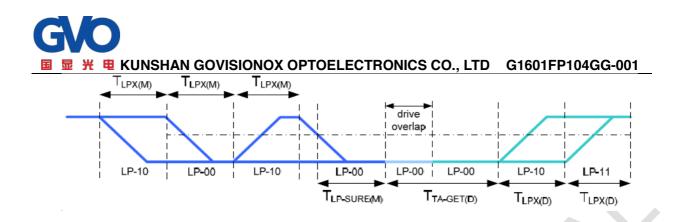
Note4: 60Hz command mode at 800 Mbps.

#### **5** AC Characteristics

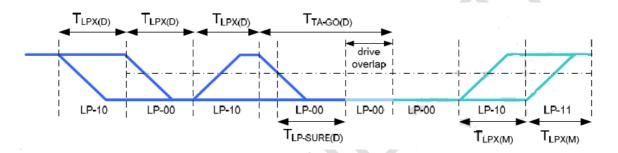
5.1 MIPI Interface Characteristics HS Data Transmission Burst



**Turnaround Procedure** 



#### Bus turnaround (BAT) from MPU to display module timing



#### Timing Parameters:

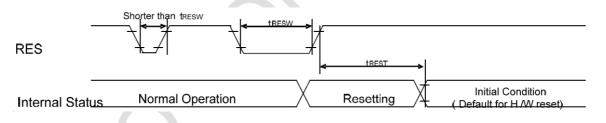
Parameter	Description	Min	Тур	Max	Unit
T <sub>CLK-POST</sub>	Time that the transmitter continues to send HS clock after the last associated Data	60ns + 52*UI			ns
	Lane has transitioned to LP Mode. Interval is defined as the period from the end of				
T <sub>CLK-TRAIL</sub>	T <sub>HS-TRAIL</sub> to the beginning of T <sub>CLK-TRAIL</sub> . Time that the transmitter drives the HS-0 state after the last payload clock bit of a HS	60			ns
_	transmission burst.				
T <sub>HS-EXIT</sub>	Time that the transmitter drives LP-11 following a HS burst.	300			ns
T <sub>CLK-TERM-EN</sub>	Time for the Clock Lane receiver to enable the HS line termination, starting from the time point when Dn crosses V <sub>IL MAX</sub> .	Time for Dn to reach V <sub>TERM-EN</sub>		38	ns
T <sub>CLK-PREPARE</sub>	Time that the transmitter drives the Clock Lane LP-00 Line state immediately before the HS-0 Line state starting the HS transmission.	38		95	ns
T <sub>CLK-PRE</sub>	Time that the HS clock shall be driven by the transmitter prior to any associated Data Lane beginning the transition from LP to HS mode.	8			UI
T <sub>CLK-PREPARE</sub> + T <sub>CLK-ZERO</sub>	T <sub>CLK-PREPARE</sub> + time that the transmitter drives the HS-0 state prior to starting the Clock.	300			ns
T <sub>D-TERM-EN</sub>	Time for the Data Lane receiver to enable the HS line termination, starting from the time point when Dn crosses V <sub>IL.MAX</sub> .	Time for Dn to reach V <sub>TERM-EN</sub>		35 ns +4*UI	



#### ■ 光 电 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

	INSTIAN GOVISIONON OF TOLLEG		,	<u>,                                    </u>				
T <sub>HS-PREPARE</sub>	Time that the transmitter drives the D Lane LP-00 Line state immediately be the HS-0 Line state starting the HS transmission	efore	40ns + 4*UI		85 ns	+ 6*UI		ns
T <sub>HS-PREPARE</sub> + T <sub>HS-ZERO</sub>	T <sub>HS-PREPARE</sub> + time that the transmitt drives the HS-0 state prior to transmitting the Sync sequence.	er	145ns + 10*UI					ns
T <sub>HS-TRAIL</sub>	Time that the transmitter drives the fli differential state after last payload dat of a HS transmission burst		60ns + 4*UI					ns
Parameter	Description	Min	Тур	M	ax	Unit	No	tes
T <sub>LPX(M)</sub>	Transmitted length of any Low-Power state period of MCU to display module	50		15	50	ns	1,2	2
T <sub>TA-SURE(M)</sub>	Time that the display module waits after the LP-10 state before transmitting the Bridge state (LP-00) during a Link Turnaround.	T <sub>LPX(M)</sub>		2*	T <sub>LPX(M)</sub>	ns	2	
T <sub>LPX(D)</sub>	Transmitted length of any Low-Power state period of display module to MCU	50		15	50	ns	1,2	2
T <sub>TA-GET(D)</sub>	Time that the display module drives the Bridge state (LP-00) after accepting control during a Link Turnaround.		5*T <sub>LPX(D)</sub>			ns	2	
T <sub>TA-GO(D)</sub>	Time that the display module drives the Bridge state (LP-00) before releasing control during a Link Turnaround.		4*T <sub>LPX(D)</sub>			ns	2	
T <sub>TA-SURE(D)</sub>	Time that the MPU waits after the LP-10 state before transmitting the Bridge state (LP-00) during a Link Turnaround.	T <sub>LPX(D)</sub>	-	2*	T <sub>LPX(D)</sub>	ns	2	

#### 5.2 Display RESET Timing Characteristics Reset input timing:



#### VDDIO=1.65 to 3.3V, VDD=2.7 to 3.6V, AGND=DGND=0V, Ta=-40 to $85^{\circ}$ C

**Timing Parameters** 

Symbol	Parameter	Related Pins	MIN	TYP	MAX	Note	Unit
t <sub>RESW</sub>	*1) Reset low pulse width	RESX	10	-	-	-	μs
+	*0) D	-	-	-	5	When reset applied during Sleep in mode	ms
<b>I</b> REST	*2) Reset complete time	-		-	120	When reset applied during Sleep out mode	ms

Note1.Spike caused by an electrostatic discharge on RESX line does not cause irregular system reset according to the table below.

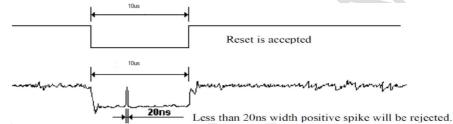


RESX Pulse	Action
Shorter than 5µs	Reset Rejected
Longer than 10μs	Reset
Between 5µs and 10µs	Reset starts (It depends on voltage and temperature condition.)

Note 2. During the resetting period, the display will be blank (The display is entering blanking sequence, whose maximum time is 120 ms, when Reset Starts in Sleep Out – mode. The display remains blank in Sleep In – mode) and then return to Default condition for H/W reset.

Note 3. During Reset Complete Time, data in OTP will be latched to internal register during this period. This loading is done every time when there is H/W reset complete time (tREST) within 5ms after a rising edge of RESX.

Note 4. Spike Rejection also applies during a valid reset pulse as shown below:



Note 5. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

#### 5.3 TE Timing Characteristics

Mode1, The Tearing Effect Output line consists of V-Blanking information only.

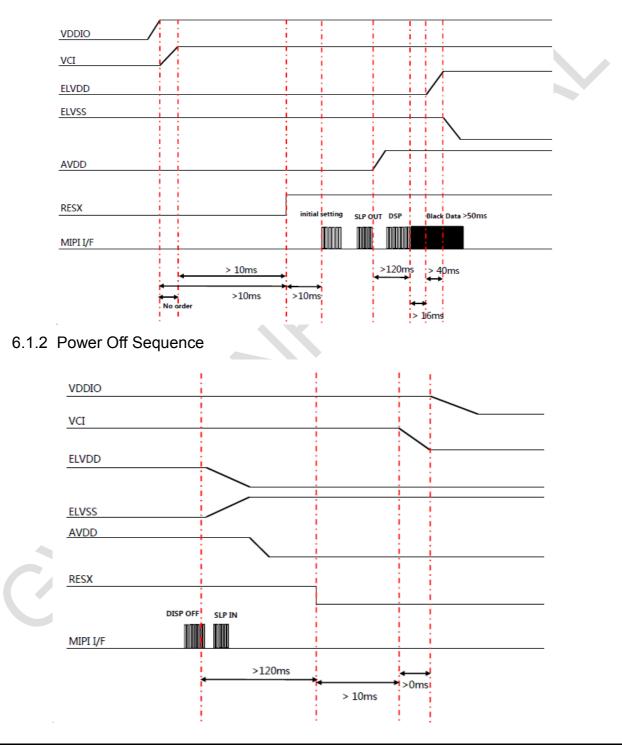


Tvdh = The display is not updated from the frame memory.Tvdl = The display is updated from the frame memory.



## 国 显光电KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001 6 Recommended Operating Sequence

- 6.1 Display Power on / off Sequence
  - 6.1.1 Power On Sequence



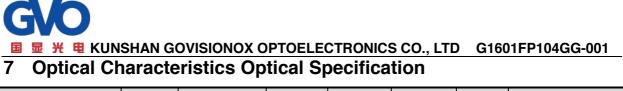


国 显 光 电 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

#### 6.2 Brightness control

Use "command 5100h, data xxh" to adjust the Manual Brightness value of the display: In principle relationship is that 00h value means the lowest brightness and FFh value means the highest brightness.

Inst/Dara		Address			Description	
Inst/Para	R/W	MIPI	Other	Date Type	Description	
BRTCTRL	W	51h	5100h	Hex	Value form 0~255(FF)	



Item		Symbol	Condition	Min	Тур	Мах	Unit	Remark
		θТ		80	-			
		θΒ	00540	80	-			Note 2
View Angle		θL	CR≥10	80	-		Degree	Test Equipment: CS2000A
		θR		80	-			00200011
								Note1,Note3
Contrast Rat	io	CR	θ=0°	100000				Test Equipment: CS2000A
		T <sub>ON</sub>	<b>05</b> °0			4		Note1,Note4
Response Ti	me	$T_{OFF}$	<b>25</b> ℃			1	ms	Test Equipment: Admesy MSE
	White	х		(0.280)	(0.300)	(0.320)		
	vvnite	У		(0.295)	(0.315)	(0.335)		
	Red	х		(0.625)	(0.655)	(0.685)		Test Equipment: CS2000A
Chromaticity	Reu	У		(0.315)	(0.345)	(0.375)		Note: Chromaticity
Chromaticity	Green	х		(0.210)	(0.250)	(0.290)		can be modified
	Green	у		(0.670)	(0.710)	(0.750)		according to customer demand
	Blue	x		(0.105)	(0.135)	(0.165)		domand
	Diue	у		(0.030)	(0.060)	(0.090)		
								Note1,Note6
Uniformity		U		75			%	Test Equipment: CS2000A
NTSC				90	100		%	Note5
								Note1,Note7
Luminance		L	Normal	365	430	495	Cd/m <sup>2</sup>	Test Equipment: CS2000A
								Note8
Cross-talk						1.5	%	Test Equipment: CS2000A
								Gamma=2.2±0.2
Gamma				2.0	2.2	2.4		Test Equipment: CS2000A

Test Conditions:

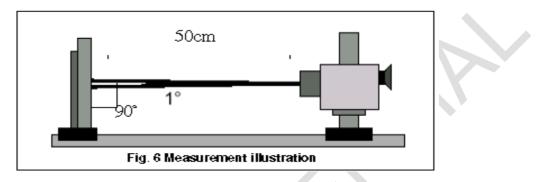
the ambient temperature is  $25^{\circ}$ C.

 Image: Second state
 Image: Second state<

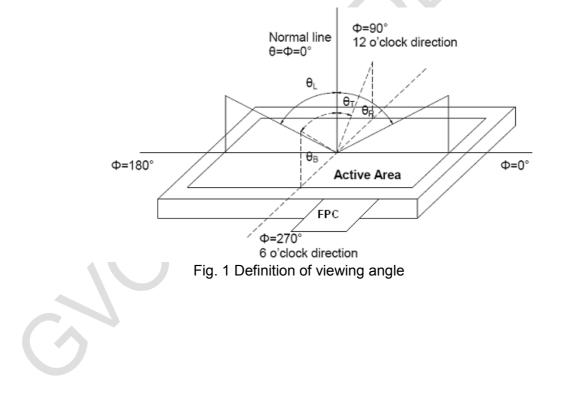
GVO B # # KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. The optical properties are measured at the center point of the AMOLED screen. All input terminals AMOLED panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system.



## ■ ₩ ₩ KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

Note 3: Definition of contrast ratio

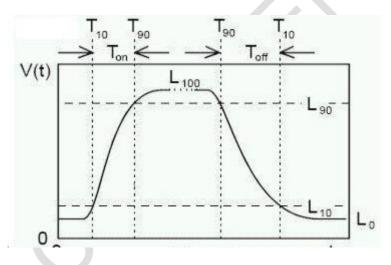
 $Contrast ratio(CR) = \frac{Lumin ance measured when LCD is on the "white" state}{Lumin ance measured when LCD is on the "Black" state}$ 

"White state ": A state where the AMOLED should be driven by Vwhite.

"Black state": A state where the AMOLED should be driven by Vblack.

Note 4: Definition of response time

The response time is defined as the AMOLED optical switching time interval between "White" state and "Black" state. Rise time  $(T_{ON})$  is the time between photo detector output intensity changing from 10% to 90%. And fall time  $(T_{OFF})$  is the time between photo detector output intensity changing from 90% to 10%.



Note 5: Definition of color chromaticity (CIE1931) Color coordinates are measured at the center point of AMOLED.

## GVO B W H KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

Note 6: Definition of luminance uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity(U) = Lmin/ Lmax

L-----Active area length W----- Active area width

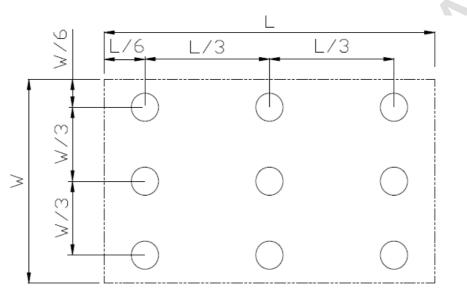


Fig. 2 Definition of uniformity

Lmax: The measured maximum luminance of all measurement position.

Lmin: The measured minimum luminance of all measurement position.

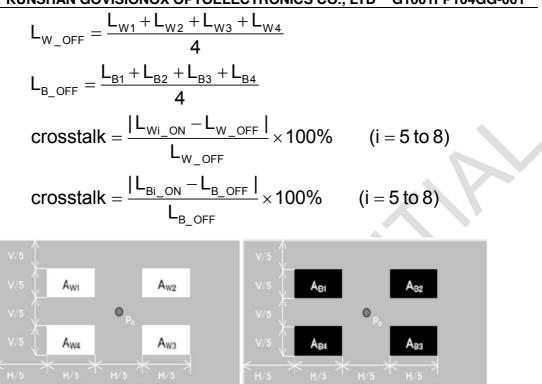
Note 7: Definition of luminance:

Measure the luminance of white state at the center point.

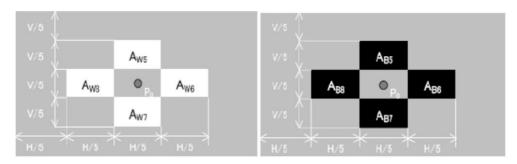
Note 8: Cross Talk

- A. Measure luminance at the position, P0.
- B. Calculate cross talk as below equation.

**■** ₩ **■** KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001



(a) Lw\_OFF, LB\_OFF measuring pattern



(b)  $L_{W_ON}$ ,  $L_{B_ON}$  measuring pattern



#### ■ 〒 米 电 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001 8 Environmental / Reliability Test

No	Test Item	Condition	Remark
1	High Temperature Operation	+70℃, 120hrs	According to the customer request
2	Low Temperature Operation	-20℃, 120hrs	According to the customer request
3	High Temperature Storage	+80℃, 120hrs	According to the customer request
4	Low Temperature Storage	- <b>30</b> ℃, 120hrs	According to the customer request
5	High Temperature & High Humidity Operation	60℃, 90% RH,120hrs	According to the customer request
6	High Temperature & High Humidity Storage	60℃, 90% RH,120hrs	According to the customer request
7	Thermal Shock (Non-operation)	-30℃(30 min)~+70℃(30 min), Change time:10min, 30Cycles	According to the customer request
8	Electro Static Discharge (Operation)	C=150pF, R=330 $\Omega$ , 5points/panel Air:±8KV, 5times; Contact:±4KV, 5 times; (Environment: 15°C~35°C, 30%~60%, 86Kpa~106Kpa).	IEC61000-4-2 GB/T17626.2



#### **国 显 光 电 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD** G1601FP104GG-001

#### 9 Quality Level

9.1 AMOLED Module of Characteristic Inspection

The environmental condition and visual inspection shall be conducted as below:

- (1) Ambient temperature: 23± 3℃
- (2) Humidity:  $55 \pm 10\%$ RH
- (3) Ambient light intensity of visual inspection: 800 ~ 1200 lux
- (4) Ambient light intensity of function inspection:  $\leq$ 200lux
- (5) Viewing Distance: 30 ± 5cm
- (6) Viewing angle (tolerance): the front side  $45^{\circ}$  (Z)  $\pm 15^{\circ}$
- (7) Inspection time: 10 ±5 sec

#### 9.2 Sampling Procedures for each item acceptance table

Defect type	Sampling Procedures	AQL
	GB/T2828.1-2003 Inspection level II	
Major defect	normal inspection	0.65
,	single sample inspection	
	GB/T2828.1-2003 Inspection level II	
Minor defect	normal inspection	1.0
	single sample inspection	

Major defect:

Any defect may result in functional failure, or reduce the usability of product for its purpose. For example, electrical failure, deformation and etc.

#### Minor defect

A defect does not reduce the usability of product for its intended purpose and un-uniformity, such as dot defect and etc.

The criteria on major and/or minor judgment will be according with the classification of defects.

#### 9.3 Inspection Item

No	Item	Area		Criterion of Defect					
			Туре		DS	Acceptabl e number			
1		A A	Bright Dot	≥10mm	0				
	Dol Deleci	Dot Defect AA	Dark Dot	≥10mm	4	Minor			
				≥10mm 2					



#### ■ ¥ 电 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

1 $\neg$	•	显光 电 KUNSHAN	GOVISION	NOX OPTOELECT	RUNICS CO., LI	D G160	1FP104GG-00	<u>,                                     </u>	
2Not DisplayAA $/$ allowedPata3Abnormal DisplayAA/allowedFatal4Normally whiteAA/allowedFatal4Normally whiteAA/allowedFatal4Normally whiteAA/allowedFatal4Normally whiteAA/allowedFatal5Line DefectAAFatalBright lineNot allowedNot allowed5Line DefectAAMultiple linesBright lineNot allowed6Image stickingAASwitch to the next screen and display the image of the previous pictureNot allowed7Color castAASee limit sample(under full white screen )Major8Color crastAASee limit sample(under full white screen )Major9Water RippleAANot allowed(under full white screen ) or See limit sample(under low gray-scale white spot, S-Line Mura)AANot allowed11TPAATP function NGNot allowedFatal13Screen bumpAA. OA/Not allowed and LTPS does not allowed assemblyFatal14Line sefects (light visible)AAM (mm)L (mm) COSScreen and allowed allowedMajor15Point sefects (light visible)AAD (mm)DS (mm)Acceptabl AcceptablMajor				connections)					
3       Abnormal Display       AA $/$ allowed       Patal         4       Normally white       AA $/$ $Not$ allowed       Fatal         4       Normally white       AA $/$ $Not$ allowed       Fatal         5       Line Defect       AA $AA$ $Bright line$ $Not$ allowed $Not$ allowed         5       Line Defect       AA $AA$ $Bright line$ $Not$ allowed $AA$ 6       Image sticking       AA       Switch to the next screen and display the image of the allowed $Not$ allowed         6       Image sticking       AA       See limit sample(under full white screen )       Major         7       Color crast       AA       See limit sample(under full white screen )       Major         8       Color crast       AA       See limit sample(under full white screen )       Major         9       Water Ripple       AA       See limit sample(under full white screen )       Major         10       grass cale white spot. S-Line Mura)       AA       See limit sample(under full white screen )       See limit sample(under full white screen )       Fatal         12       Glass crack       AA.OA $/$ $Not$ allowed	2	No Display	AA		1			Fatal	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	3	Abnormal Display	AA		/				
$ \begin{array}{ c c c c c } \hline \begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c c c } \hline \begin{tabular}{ c c c c c c } \hline \begin{tabular}{ c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	4	Normally white	AA		/			Fatal	
$ \begin{array}{ c c c c } & & & & & & & & & & & & & & & & & & &$					Bright li	ne	Not		
$ \begin{array}{ c c c c } \hline \begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c c c } \hline \begin{tabular}{ c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c c c c } \hline \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$					Dark lir	ne			
$ \begin{array}{ c c c c } \hline \begin{tabular}{ c c } \hline \hline \begin{tabular}{ c c } \hline \hline \begin{tabular}{ c c } \hline \hline \begin{tabular}{ c c } \hline \hline \begin{tabular}{ c c c } \hline \hline \begin{tabular}{ c c } \hline \hline \ \begin{tabular}{ c c } \hline \hline \begin{tabular}{ c c c } \hline \hline \begin{tabular}{ c c c } \hline \hline \begin{tabular}{ c c c } \hline \hline \ \ \begin{tabular}{ c c } \hline \hline \begin{tabular}{ c c } \hline \hline \ \begin{tabular}{ c c c } \hline \hline \hline \ \begin{tabular}{ c c } \hline \hline \ \hline \ \begin{tabular}{ c c } \hline \hline \hline \ \begin{tabular}{ c c } \hline \hline \ \begin{tabular}{ c c } \hline \hline \hline \ \ \begin{tabular}{ c c } \hline \hline \ \ \begin{tabular}{ c c } \hline \hline \ \hline \ \ \begin{tabular}{ c c } \hline \hline \ \ \ tabu$	5	Line Defect	АА	Multiple lines	Bright li	ne	allowed	Fatal	
$ \begin{array}{ c c c c } \hline \begin{tabular}{ c c } \hline \hline \begin{tabular}{ c c } \hline \begin{tabular}{ c c } \hline \hline \begin{tabular}{ c c c } \hline \hline \begin{tabular}{ c c } \hline \hline \begin{tabular}{ c c c } \hline \hline \begin{tabular}{ c c c } \hline \hline \begin{tabular}{ c c } \hline \hline \begin{tabular}{ c c } \hline \hline \begin{tabular}{ c c c } \hline \hline \begin{tabular}{ c c } \hline \hline \begin{tabular}{ c c } \hline$			701		Dark lir	ne	allowed	i atai	
Image stickingAASwitch to the next screen and display the image of the previous pictureNot allowed7Color & Edge MuraAASee limit sample(under full white screen )Major8Color crastAASee limit sample(under full white screen )Major9Water RippleAASee limit sample(under full white screen )Major9Water RippleAASee limit sample(under full white screen )Major10Other mura(Low gray-scale white spot, S-Line Mura)AANot allowed(under full white screen ) or See limit sample(under low gray-scale white spot, S-Line Mura)Not allowed(under low gray-scale white screen )Fatal11TPAATP function NGNot allowedFatal12Glass crackAA, OA//Not allowed and LTPS does not affect allowed allowed and LTPS does not affect allowedMajor13Screen bumpAA, OA $\mathbb{W}(mm)$ $\mathbb{L}(mm)$ $DS$ (mm)Acceptable e number e numberMinor14Line sefects (light visible)AA $\mathbb{D}(mm)$ $\mathbb{L} \leq 5.0$ $\geq 10$ $\mathbb{Z}$ 15Point sefects (light visible)AA $\mathbb{D}(mm)$ $\mathbb{D}S(mm)$ $\mathbb{A}$ $\mathbb{A}$				Half-Line	Bright li	ne	allowed		
oImage stickingAAprevious pictureMajor7Color & Edge MuraAASee limit sample(under full white screen )Major8Color crastAASee limit sample(under full white screen )Major9Water RippleAASee limit sample(under full white screen )Major9Water RippleAASee limit sample(under full white screen )Major10Other mura(Low gray-scale white spot, S-Line Mura)AANot allowed(under full white screen ) or See limit sample(under low gray-scale white screen )Major11TPAATP function NGNot allowedFatal12Glass crackAA, OA/Image surface is not allowed and LTPS does not affect assemblyFatal13Screen bumpAA, OAEncap surface is not allowed and LTPS does not affect assemblyMajor14Line sefects (light visible)AAW (mm)L (mm)DS (mm)Acceptabl e number14Point sefects (light visible)AAD (mm)DS (mm)Acceptabl e numberMinor							allowed		
1MuraAASee limit sample(under full white screen )Major8Color crastAASee limit sample(under full white screen )Major9Water RippleAANot allowedMajor10Other mura(Low gray-scale white spot, S-Line Mura)AANot allowed(under full white screen ) or See limit sample(under low gray-scale white screen )Major11TPAATP function NGNot allowedFatal12Glass crackAA, OA/Screen bumpFatal13Screen bumpAA, OAEncap surface is not allowed and LTPS does not affect allowedMajor14Line sefects (light visible)AA $W$ (mm)L (mm)DS (mm)Acceptabl e number14Point sefects (light visible)AAD (mm)DS (mm)Acceptabl e numberMinor15Point sefects (light visible)AAD (mm)DS (mm)Acceptabl e numberMinor	6	Image sticking	AA	Switch to the ne					
9Water RippleAANot allowedMajor10Other mura(Low gray-scale white spot, S-Line Mura)AANot allowed(under full white screen ) or See limit sample(under low gray-scale white screen)Major11TPAATP function NGNot allowedFatal12Glass crackAA, OA/Not allowed and LTPS does not allowed allowedFatal13Screen bumpAA, OAEncap surface is not allowed and LTPS does not affect assemblyMajor14Line sefects (light visible)AAW (mm)L (mm)DS (mm)Acceptabl e number14Point sefects (light visible)AAD (mm)DS (mm)Acceptabl e numberMinor15Point sefects (light visible)AAD (mm)DS (mm)Acceptabl e numberMinor	7	•	AA	See limit s	See limit sample(under full white screen )				
Other mura(Low gray-scale white spot, S-Line Mura)AANot allowed(under full white screen ) or See limit sample(under low gray-scale white screen)Major11TPAATP function NGNot allowedFatal12Glass crackAA, OA/Not allowedFatal13Screen bumpAA, OAEncap surface is not allowed and LTPS does not affect assemblyMajor14Line sefects (light visible)AAW (mm)L (mm)DS (mm)Acceptabl e number14Point sefects (light visible)AAD (mm)DS (mm)Acceptabl e numberMinor	8	Color crast	AA	See limit sample(under full white screen )					
10gray-scale white spot. S-Line Mura)AANot allowed(under full white screen ) or See limit sample(under low gray-scale white screen)Major11TPAATP function NGFatal12Glass crackAA. OA/Not allowedFatal13Screen bumpAA. OAEncap surface is not allowed and LTPS does not affect assemblyMajor14Ine sefects (light visible)AA. OA $W (mm)$ $L (mm)$ $DS (mm)$ Acceptabl e number14 $W (mm)$ $L (mm)$ $DS (mm)$ $Acceptabl$ e numberMajor15Point sefects (light visible) $AA$ $D (mm)$ $DS (mm)$ Acceptabl e numberMinor	9		AA		Not allowed	b		Major	
11IPAAIP function NGallowedFatal12Glass crackAA, OA/ $\begin{array}{c} & & \\ Not \\ allowed \end{array}$ Fatal13Screen bumpAA, OAEncap surface is not allowed and LTPS does not affect assemblyMajor14Ime sefects (light visible)AA, OA $\begin{array}{c} & W(mm) \\ W \leq 0.03 \\ 0.03 < W \leq 0.05 \\ 0.03 < W \leq 0.05 \\ 0.05 < W \\ - \\ $	10	gray-scale white spot、S-Line	AA			,		Major	
12Glass crackAA, OAImage: Patal strain str	11	TP	AA	TP	function NG		allowed	Fatal	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	12	Glass crack	AA, OA		1		allowed	Fatal	
$14 \begin{array}{ c c c c c } \hline 14 \\ 14 \\ \hline 16 $	13	Screen bump	AA、 OA	Encap surface is			es not affect	Major	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$				W (mm)	L (mm)				
$\begin{array}{c c c c c c c c c c c c c c c c c c c $		Line pofeste (light		W≤0.03	-	-	Ignore		
Image: 15 selects (light visible)     AA     D (mm)     DS (mm)     Acceptabl e number     Minor	14		AA	0.03 <w≤0.05< td=""><td>L≤5.0</td><td>≥10</td><td>2</td><td>Minor</td></w≤0.05<>	L≤5.0	≥10	2	Minor	
15Point sefects (light visible)AAD (mm)DS (mm)Acceptabl e numberMinor				0.05 <w< td=""><td>-</td><td>-</td><td>0</td><td></td></w<>	-	-	0		
15 Point sefects AA D (mm) DS (mm) e number Minor				-	L>5.0	-	0		
D≤0.1 / Ignore	15		AA	D (mm)	DS (mm	ı)		Minor	
				D≤0.1			Ignore		



#### I III H H KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

•	显光电 KUNSHAN	0.0 1.0.0.				1FP104GG-00	· ·	
			0.1 <d≤0.25< td=""><td colspan="2">≥10</td><td>2</td><td></td></d≤0.25<>	≥10		2		
			0.25 <d< td=""><td>_</td><td>-</td><td>0</td><td></td></d<>	_	-	0		
			W (mm)	L (mm)	DS (mm)	Acceptabl e number		
			W≤0.03	L<5.0	≥10	Ignore		
16	Glass scratch	AA	0.03 <w≤0.05< td=""><td>L≤2.0</td><td>≥10</td><td>Ignore</td><td colspan="2">Minor</td></w≤0.05<>	L≤2.0	≥10	Ignore	Minor	
		701	0.00 <11=0.00	2.0 <l≤5.0< td=""><td>≥10</td><td>2</td><td>WIITIO</td></l≤5.0<>	≥10	2	WIITIO	
			0.05 <w< td=""><td>-</td><td>0</td><td>0</td><td></td></w<>	-	0	0		
				L>5.0	0	0		
17	Frit Encapsulation	FA	Frit width unif	ormity. It shou breakag		oubble or	Major	
18	Polarizer crease / indentation	AA		See limit sample				
19	Protective film starved/overflow glue/burr	Except AA	No	No control under W≤0.3mm				
20	Polarizer bump point	Whole area		Bump:D≤0.25mm, dent ≤1mm or See limit sample Allow 3				
21	Polarizer bubble line	Out of AA, ≤0.25m m	Encap s	urface	Not	allowed	Minor	
22	Scratches on the surface of polarizer	Whole area	No harm	n subject rega	rdless of con	itrol	Minor	
				D(mm)	DS (mm)	Acceptabl e number		
	Concave dot、 Black and white		Front (Encap	D≤0.1	≥10	Ignore		
23	dot, Polarizer Dent/Bubble	AA	surface)	0.1< D≤0.2	≥10	3	Minor	
				0.2 <d< td=""><td>≥10</td><td>0</td><td></td></d<>	≥10	0		
			Metal material foreign material	/	≥10	Not allowed		
	Polarizer Scratch/		W (mm)	L (mm)	DS (mm)	Acceptabl e number		
24	Fiber(Linear)	AA	W≤0.03	L≤5.0	≥10	Ignore	Minor	
			0.03 <w≤0.05< td=""><td>L≤2.0 2.0&lt;</td><td>≥10 ≥10</td><td>Ignore 3</td><td></td></w≤0.05<>	L≤2.0 2.0<	≥10 ≥10	Ignore 3		
<u> </u>						•		



I III 😾 💥 🤨 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

•	显光电 KUNSHAN	GOVISIO	NOX OPTOELE	CTRONICS C	)., LT	D G160	01FP104GG-00	<u>)1</u>	
			0.05 <w< td=""><td>-</td><td></td><td>≥10</td><td>0</td><td></td></w<>	-		≥10	0		
			The Caller Sec	L>5.0		≥10	0		
			I ne tollowing	Criterion is ap	-	ble to any	/ side (unit:		
				mn	1)		Assantable		
	Edge/Side		Z	Х		Y	Acceptable number		
25	breakage	OA				not	number	Minor	
	5			10.0		nded to			
			≤T	≤2.0		uit Area	<5		
				or Frit					
		Not IC		Over coating Not allowed					
		side	The coeting	The coating of IC side is not higher than Not allowed					
26	UV glue	IC side	POL.	of IC side is no	t nign	er than	Not allowed	Minor	
				of IC side is no	t hiah	er than	Not		
		IC side	POL.				allowed		
		IC and	The coating s	The coating should not have breakage or Bubble.					
		FPC							
	bondin		The coating is not higher than POL.						
	27 Tuffy glue	g area	Tuffy alue is i	not allowed to	intorr	unt and th	ne diameter	Minor	
27		Other		not more than (					
21		area		s not higher th					
		IC	Not allowed						
				the width is no	t mor	e than 1r	nm.		
		FPC	Dot glue: the	diameter is no	t mor	e than 2r	nm.		
	Rear	500	The width is	not more than	1mm				
28	reinforcement	FPC		lower than LT				Minor	
	glue of FPC		The length of	attachment is	more	than hot	h ends of		
		Bondin	FPC, which should be range from 0.2 to 1mm. Don't go beyond the edge of panel.						
29	ACF	g Area	Effective lap width of wiring ACF is more than 2/3,						
		graca	which is compared with the width of the gold finger of						
			FPC.	ubble or wrinkl	<u> </u>				
				ent can not rev		nolarity			
			No wrong ins		0100	polarity			
			•		is cre	ase whic	h destrov the		
			FPC should not have serious crease which destroy the line, prick and spots damage. Scratch is not allowed if						
30	FPCA	FPC	Cu layer is ex	kposed.				Minor	
			The gold fingers should not be oxidized, scraped,					Minor	
				ssed, broken,					
			Make sure FPC is not scalded, with its location holes						
	not having deficiency or obviously shift. The component of FPC should be the same as BC					ne as BOM			
L		I				c ine san		l	



#### 国 显 光 电 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

			list.		
			No remaining soldering Sn		
			No visual particle on the pad line		
			Bubble: Visible bubble is not allowed		
	FPC bonding	Bondin	Overhang : The size above 1/2 of soldering electrode		
31		g area	of the parts overhang to the LAND is prohibited. The tilt	Minor	
		y area	height less than 0.5mm between FPC and foam.		
32	FPC Skew		Not allowed		
			Products should put into the anti-static trays, with		
			non-overlapping, and the trays should be staggered	×	
			placed. Different products cannot be mixed into the same inner		
32	Package	Other	package.	Minor	
02	T donage		The package should not have obvious deformation or	WIIIIOI	
			breakage .The printing labels type and quantity are		
			correct.		
			The package should have QC signature. ROHS label is		
			needed if the product is under ROHS control.		
Insp	ection standard for c	cover			

No	Item	Area	Criterion of Defect			Defec t type		
33	Cover dot、Black and white dot、 Polarizer	Whole area	D (mm)		DS (mm)	Acceptable number		
			D≪0.15mm		1	Ignore (specks is not allowed)	Minor	
	Dent/Bubble		0.15mm <d< td=""><td>&lt;0.25mm</td><td>DS≥10mm</td><td>2</td><td></td></d<>	<0.25mm	DS≥10mm	2		
			D>0.25mm		/	Not allowed		
			Specks: D	<0.15mm,N	I>5 in 10mm*	10mm area		
		AA	W(mm)	L(mm)	DS(mm)	Acceptable number		
			W≤0.03mm	L≪10mm	≥10	Ignore		
	Cover Scratch/ Fiber(Linear)		0.03mm <w< td=""><td>L≤5.0mm</td><td>≥10</td><td>2</td><td>Minor</td></w<>	L≤5.0mm	≥10	2	Minor	
34			≪0.05mm				WITTOT	
0.			W>0.05	/	/	Not		
						allowed		
			/	L>5.0mm	/	Not allowed		
			Not allowed to scratch					
35	Edge pinhole	Edge of cover	D (mm)	DS (mm)	Acceptable number			
			D< 0.1mm	DS≥ 10mm	one is allowed on each side	4	Minor	



I 显光电 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

Ħ	■ 光电 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001					<u> </u>		
			W (B or D)		L(A or C)	Acceptable number		
			W≤0.15mm		L≪3mm	≦2		
36 Uneven edge of Edge of the ink cover		Edge of cover					Minor	
			D(mm)		DS (mm)	Acceptable		
37	ink silk screen serrated	OA				number	Minor	
		area	D≤0.2		DS≥10mm	2		
38	Camera Hole	OA area	breakage or crack: D≤ 0.1mm Hole is not round: Refer to the limit sample Dot Defect: D≤0.1mm, and N≤1, heterochrosis and line defect are not allowed; Camera hole smudge:not allowed		인쇄물링 se 2	Minor		
39	Printing defect	OA area	Wrongly, Missing, Ghosting and incomplete printing : not allowed Fonts consistent with the standard characters, no significant difference in visualization Penetrating scratch is not allowed			Minor		
			DS(mm)	-	cceptable		L	
	•	$\bigcirc$	、 <i>'</i>	number	•	一漏	6	
			DS<0.1	Igno	re			
			0.1≤DS≤0.15	1			Į,	
40		OA area	Note: Not visible on black background, don't affect the transmission rate Foreign body, dirty in IR hole: not allowed Scratched\Line defects in IR hole: $W \leq 0.03$ mm, $L \leq 1$ mm, $N \leq 1$ , Not visible on black background, don't			_ Minor		
			affect the transmission rate.					
	Residual glue in IR hole: not allowed			250				
	Cover lens	OA area	Raised height<0.15mm, and the are of the entire non-display area in					
41	41 deformation AA area		Deformation is not allowed in AA area			Minor		

The information contained herein is the exclusive property of KUNSHAN GOVISIONOX OPTOELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of KUNSHAN GOVISIONOX OPTOELECTRONICS Corporation.



■ 🕱 🖶 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

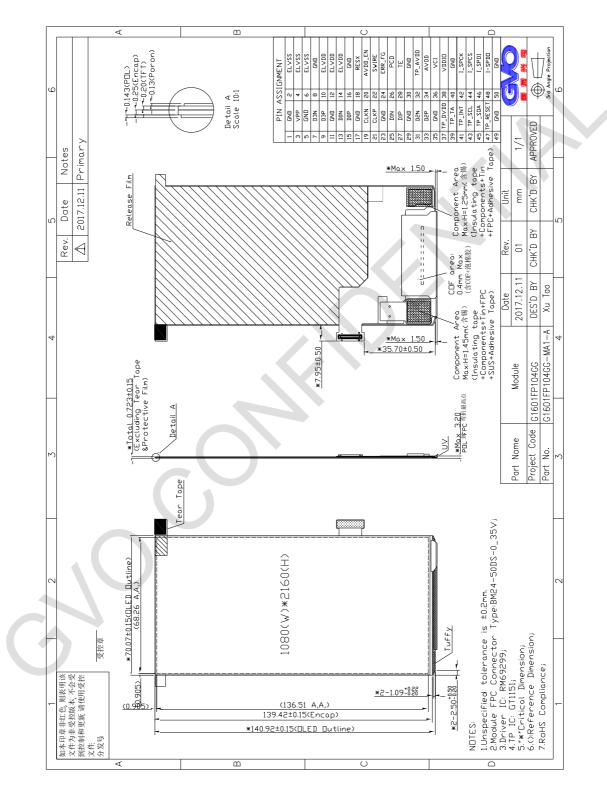
<b></b>			IOX OPTOELECTRONICS CO., LTD G160TFP104GG-00			
42	Poor penetration of icons	OA area	DS $\leqslant$ 0.15 and N $\leqslant$ 1	Minor		
43	Cover dirt			Minor		
44	Cover crack Whole		Not allowed	Fatal		
45	Cover paint chips	area				
46	Durr	Edge of	· · · · ·			
40	Burr	cover	affect the assembly and function and user operation)			
47	colour difference	OA	5			
77		area	limit sample if necessary)			
48	Overfill	Whole area	Not allowed in AA area The visible part of the periphery can not be seen after assembly, and can not affect the assembly	Minor		
			Film position deviation ≤0.15mm			
49	Protective film	Whole area	Scratch: no control when don't damage the body			
43	Protective film		Overfill/ lack of plastic/ Burr: no control			
			Not control the bubble inside the cover protection film			
		Cover	Function failure\ damaged\ Missing label: not allowed			
50	50 Easy to tear su		Wrinkle\ Convex-concave point\dirty\ punching\burr\ squeeze out: not control			
			Don't go beyond the edge of panel.			
			Folds\ Light leakage\ Impact assembly or thickness:			
	Composite tape		not allowed			
			Damaged: not allowed			
			Bump does not affect the assembly: not control			
= 4			Punching the bad size meet the drawings			
51		LTPS	requirements: not control			
			Non-wipe dirty\foreign body: not allowed			
			Foreign objects in accordance with the standard line/point			
			Burr does not exceed the screen edge: not control			
			Do not have obvious bubbles			
			Gumflower\Overfill: no control			
52	Film warpage	Whole area	Warpage ≤0.2mm			
53	ICON hole	OA area	chromatic aberration、double image、dot defect 、 line			
			defect: not allowed (or refer to limited sample)			
		<u></u>	left-right asymmetry , Hole Rather large/small or off			
54	Earpiece hole	OA	normal(Out of specification)No chamfer, Uneven			
		area	polishing: not allowed	Minor		
55	Ink bumps	OA	Positive side reference point defects; The back side			
55		area	does not affect the assembly; Ink overflow or			



#### ■ 📱 🖽 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001

			accumulation: not allowed				<u> </u>
			Front : Height & depth $\leq$ 0.15mm, size $\leq$ 0.4mm, if				
56	Cover concave	Whole	necessary reference limit sample				
	convex point	area			fit process is no		
	Insulation Tape	Bondin g area	Obvious wrinkles and bubbles: not allowed				
		Compo nent area	Scratch/ Gumflower: not control				
57				Non-wipe di	irty: not allowed		Minor
			Offset can n		e edge of the protocol to the drawings		
					fill: not control		
			Damaged		missing paste: r	not allowed	
	Cover edge/side breakage	e cover	X	Y	Z	D Accepta S ble number	
			X<0.2mm	Y<0.2mm	Z≤1/2t	D Unilateral S $\leq 2$ 5	
58			X>0.2mm			m m not allowed	Minor
			/	Y>0.2mm	/	not allowed	
			/	/	 Z>1/2T	not allowed	
			Cracks are not allowed	<u>///</u>	X	Y	
59	Blunt	Whole area	Not allowed			Fatal flaw	
60	Fit bubble	AA	According to the punctate specifications			Minor	
61	Vision area edge defect	OA	D≤0.2mm, DS>10,N≤2 (hole saw tusk less than 2), if necessary reference limit sample.			Minor	
62	Cover heterochrosis	OA	Heterochrosis side execute according to point defect size, bulk/stick refer to Limited sample			Minor	

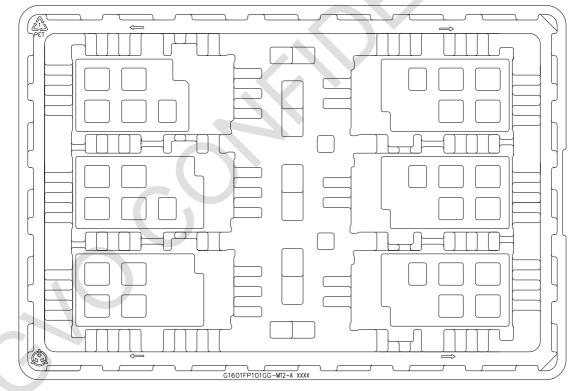






#### | 显光电 KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001 Packing Drawing

Packing Condition	Contents		
Packing Type	TRAY + Carton packing type		
TRAY material model	tray (10⁵~10 <sup>9</sup> Ω)		
Tray packing type	See the picture 1		
Number of panels per tray	6 pieces		
Number of Tray per carton	28units ((26 units + 2empty)PET tray )		
Number of panels per carton	156pieces		



Picture 1



#### ■ 〒 ★ H KUNSHAN GOVISIONOX OPTOELECTRONICS CO., LTD G1601FP104GG-001 11 Precautions for Use of AMOLED Modules

#### 11.1 Handling Precautions:

- 11.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from height.
- 11.1.2 Do not press down the screen on the adjoining areas too hard because the color tone may be shifted.
- 11.1.3 The polarizer covering the display surface of the AMOLED module is soft and easily scratched. Handle this polarizer carefully.
- 11.1.4 If the display surface is contaminated, blow on the surface and gently wipe it with a soft dry cloth. If it is still not completely clear, moisten the cloth with ethyl alcohol.
- 11.1.5 Solvents may damage the polarizer. Do not use water, ketone or aromatic solvents except ethyl alcohol.
  - Do not attempt to disassemble the AMOLED Module.
- 11.1.6 If the logic circuit power is off, do not apply the input signals.
- 11.1.7 To prevent destruction from static electricity, be careful to maintain an optimum working environment.
- 11.1.8 Be sure to make yourself in contact with the ground when handling with the AMOLED Modules.
- 11.1.9 Tools required for assembly, such as soldering irons, must be properly ground.
- 11.1.10 To reduce the generation of static electricity, do not conduct assembly or other work under dry conditions.
- 11.1.11 To protect the display surface, the AMOLED Module is coated with a film. Be careful when peeling off this protective film, because static electricity may generate.
- 11.2 Storage Precautions:
- 11.2.1 When storing the AMOLED modules, be sure that they are not directly exposed to the sunlight or the light of fluorescent lamps.
- 11.2.2 The AMOLED modules should be stored under the storage temperature range. If the AMOLED modules will be stored for a long time, the recommended condition is: Temperature: 0°C~40°C Relatively humidity: ≤80%
- 11.2.3 The AMOLED modules should be stored in the room without acid, alkali or harmful gas.
- 11.3 Transportation Precautions:
- 11.3.1 The AMOLED modules should not be suffered from falling and violent shocking during transportation. Besides, excessive press, water, damp and sunshine, should be avoided.